

PARA LIGHT ELECTRONICS CO., LTD. 4F, No.1, Lane 93, Chien Yi Road, Chung Ho City, Taipei, Taiwan

Tel: 886-2-2225-3733 Fax: 886-2-2225-4800

E-mail: para@para.com.tw http://www.para.com.tw

DATA SHEET

PART NO.: L-T670LBCT-U1

| CUSTOMER'S APPROVAL: | DC | CC : | |
|-----------------------------|-------------------|------|---------|
| DRAWING NO. : DS-7A-07-0006 | DATE · 2020-08-31 | PAGE | 1 of 15 |



Part No.: L-T670LBCT-U1 REV: B/2

0.75

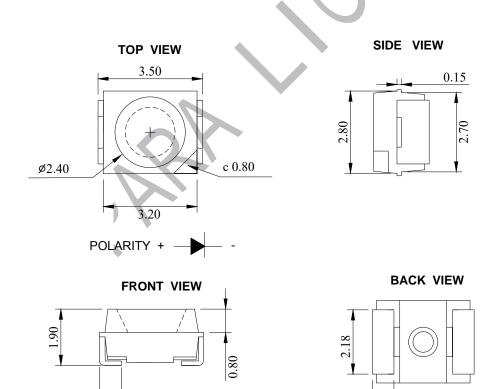
Features

- * Top view, Wide view angle, Blue color PLCC 2 package SMD LED.
- * EIA STD package, packing in 8mm tape on 7" diameter reels (ANSI/EIA-481-B-2001).
- * Compatible with automatic Pick & Place equipment.
- * Compatible with IR Reflow soldering and TTW soldering.
- * Pb free product and acceptable lead-free process.
- * Meet RoHS Green Product.

Application

- **★** Backlighting (Switches, keys, displays, illuminated advertising)
- * Emergency lighting / Signal and symbol luminaries.

Package Outline Dimensions



Notes:

- 1. All dimensions are in millimeters.
- 2. Tolerance is \pm 0.10mm (.004") unless otherwise noted.

0.75

DRAWING NO.: DS-7A-07-0006 DATE: 2020-08-31 PAGE 2 of 15



Part No.: L-T670LBCT-U1 REV: B/2

CHIP MATERIALS

Dice Material : InGaNLight Color : Blue

* Lens Color: Water Clear

● Absolute Maximum Ratings(Ta=25°C)

| Symbol | Parameter | Rating | Unit | |
|--------|--|--------------------------------------|--------------|--|
| PD | Power Dissipation | 75 | mW | |
| Inc | Peak Forward Current | 100 | A | |
| Ipf | (1/10 Duty Cycle, 0.1ms Pulse Width) | 100 | mA | |
| IF | Continuous Forward Current | 20 | mA | |
| VR | Reverse Voltage | 5 | V | |
| ESD | Electrostatic Discharge Threshold(HBM) ^{Note A} | 1000 | V | |
| Topr | Operating Temperature Range | -40 ~ + 100 | °C | |
| Tstg | Storage Temperature Range | - 40 ∼ + 100 | °C | |
| T 11 | Soldering Tomas anatyra (One times MAY) | Reflow Soldering:260°C (for 10second | r 10seconds) | |
| Tsld | Soldering Temperature (One times MAX.) | Hand Soldering:300°C (for 3 seconds) | | |

Note A:

HBM : Human Body Model. Seller gives no other assurances regarding the ability of to withstand ESD.

• Electro-Optical Characteristics (Ta=25°C)

| Parameter | Symbol | Min. | Тур. | Max. | Unit | Test Condition | |
|---------------------|---------|------|------|---------|--------|----------------|--|
| Luminous Intensity | IV | 350 | 480 | | mcd | IF=20mA | |
| Viewing Angle | 2 θ 1/2 | | 120 | | Deg | | |
| Peak Emission | 1 n | | 465 | | nm | IF=20mA | |
| Wavelength | λр | | 403 | | nm | ır−20mA | |
| Dominant Wavelength | λD | | 470 | | nm | IF=20mA | |
| Spectrum Radiation | Δλ | | 25 | | 40.400 | IF=20mA | |
| Bandwidth | ΔΛ | 23 | nm | IΓ-20MA | | | |
| Forward Voltage | VF | | 3.0 | 3.6 | V | IF = 20mA | |
| Reverse Current | IR | | | 10 | μА | VR = 5V | |

DRAWING NO.: DS-7A-07-0006 DATE: 2020-08-31 PAGE 3 of 15



Part No.: L-T670LBCT-U1 REV: B/2

Notes:

- 1. Luminous intensity is measured with a light sensor and filter combination that proximities the CIE eye-response curve.
- 2. θ 1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. Caution in ESD:
 - Static Electricity and surge damages the LED. It is recommended use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.
- 4. Major standard testing equipment by "Instrument System" Model: CAS140B Compact Array Spectrometer and "KEITHLEY" Source Meter Model: 2400.

Typical Electro-Optical Characteristics Curves

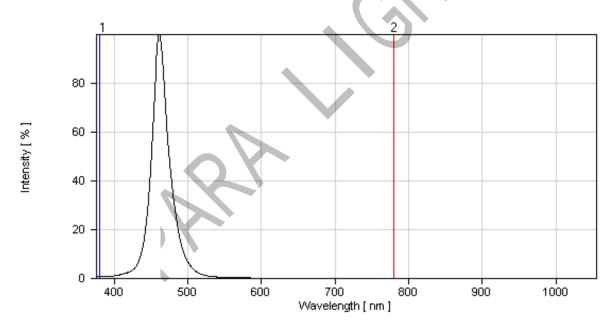


Fig.1 Relative Intensity vs. Wavelength

DRAWING NO.: DS-7A-07-0006 DATE: 2020-08-31 PAGE 4 of 15



Part No.: L-T670LBCT-U1 REV: B/2

Typical Electro-Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

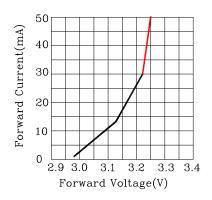


Fig.1 Forward Current vs.Forward Voltage

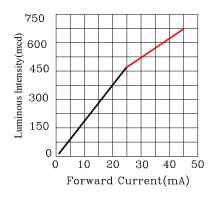


Fig.2 Luminous Intensity vs.Forward Current

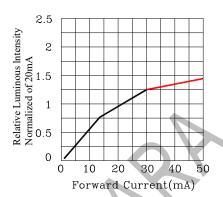


Fig.3 Relative Luminous Intensity vs.Forward Current

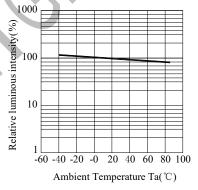


Fig.4 Luminous Intensity vs. Ambient Temperature

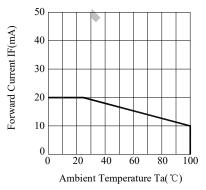


Fig.5 Forward Current Derating Curve

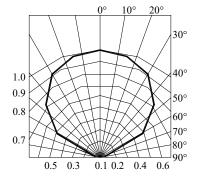


Fig.6 Relative Intensity vs.Angle

DRAWING NO.: DS-7A-07-0006 DATE: 2020-08-31 PAGE 5 of 15



Part No.: L-T670LBCT-U1 REV: B/2

Bin Code List

| Luminous Intensity(IV), Unit:mcd@20mA | | | | |
|---------------------------------------|-----|-----|--|--|
| Bin Code | Min | Max | | |
| P17 | 350 | 430 | | |
| P18 | 430 | 530 | | |
| P19 | 530 | 650 | | |
| | | | | |
| | | | | |
| | | | | |
| | | | | |
| | | | | |

| Forward Voltage(VF), Unit:V@20mA | | | | |
|----------------------------------|-----|-----|--|--|
| Bin Code | Min | Max | | |
| 14 | 2.9 | 3.0 | | |
| 15 | 3.0 | 3.1 | | |
| 16 | 3.1 | 3.2 | | |
| 17 | 3.2 | 3.3 | | |
| 18 | 3.3 | 3.4 | | |
| 19 | 3.4 | 3.5 | | |
| 20 | 3.5 | 3.6 | | |
| C | - | | | |

Tolerance of each bin are $\pm 10\%$

Tolerance of each bin are ± 0.1 Volt

| Dominant Wavelength (Hue),Unit: nm@20mA | | | | | |
|---|------------------|-----|--|--|--|
| Bin Code | Bin Code Min Max | | | | |
| AC | 465 | 470 | | | |
| AD | 470 | 475 | | | |

Tolerance of each bin are ± 1nm

DRAWING NO.: DS-7A-07-0006 DATE: 2020-08-31 PAGE 6 of 15



Part No.: L-T670LBCT-U1

REV: B/2

Label Explanation

CUS. PART NO: To be denominated.

CUSTOMER: To be denominated.

PART NO: Refer to P15

P16--- Luminous Intensity Code

16--- Forward Voltage Code

AC--- Dominant Wavelength

LOT NO: E L S 7 8 0001
A B C D E F

A---E: For series number

B---L: Local F: Foreign

C---S: SMD

D---Year

E---Month

F---SPEC.

PACKING QUANTITY OF BAG:

2000pcs for T670 series

2000pcs for T650 series

2000pcs for S020 series

DATE CODE: <u>2007</u> <u>08</u> <u>29</u>

G H I

G--- Year

H--- Month

I --- Day

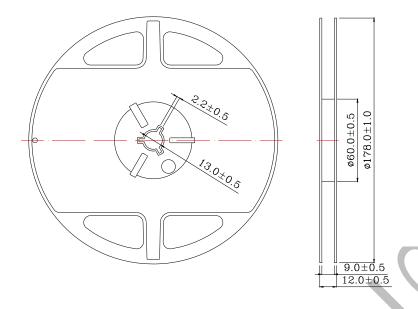
DRAWING NO.: DS-7A-07-0006 DATE: 2020-08-31 PAGE 7 of 15



Part No.: L-T670LBCT-U1

REV: B/2

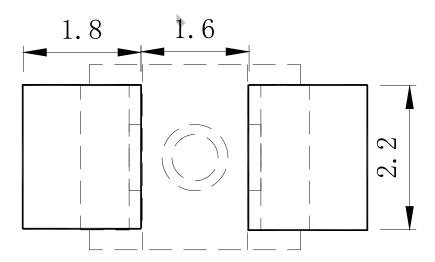
Reel Dimensions



Notes:

- 1. Taping Quantity: 2000pcs
- 2. The tolerances unless noted is ± 0.1 mm, Angle $\pm 0.5^{\circ}$, Unit: mm.

Suggest Soldering Pad Dimensions

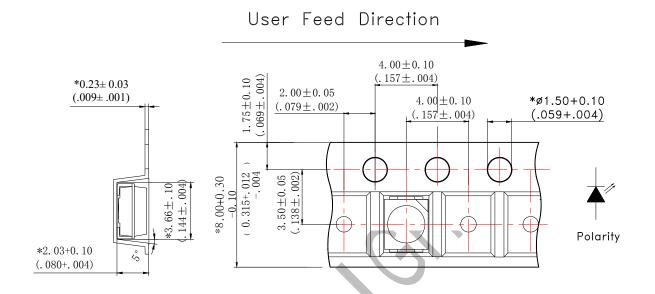


DRAWING NO.: DS-7A-07-0006 DATE: 2020-08-31 PAGE 8 of 15



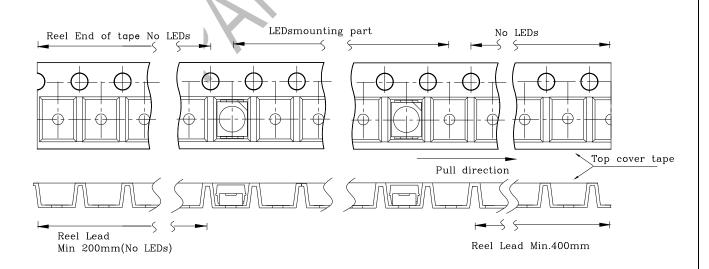
Part No.: L-T670LBCT-U1 REV: B/2

Package Dimensions Of Tape And Reel



Notes: All dimensions are in millimeters.

Packaging Of Electronic Components On Continuous Tapes

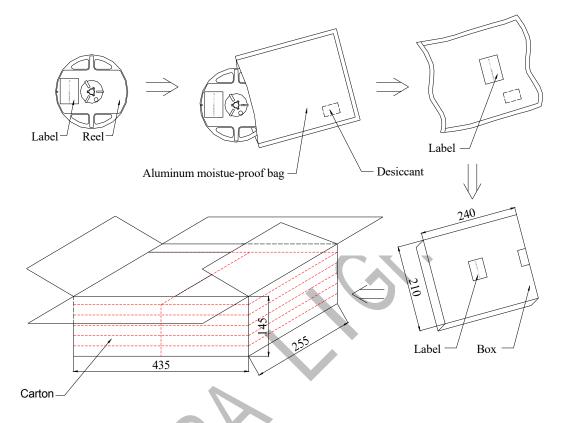


DRAWING NO.: DS-7A-07-0006 DATE: 2020-08-31 PAGE 9 of 15



Part No.: L-T670LBCT-U1 REV: B/2

Moisture Resistant Packaging



Notes: One reel in a bag, one bag in a inner box, ten inner boxes in a carton. Unit: mm.

Cleaning

- * If cleaning is required, use the following solutions for less than 1 minute and less than 40°C.
- * Appropriate chemicals: isopropyl alcohol. (When using other solvents, it should be confirmed beforehand whether the solvents will dissolve the package and the resin or not.)
- * Effect of ultrasonic cleaning on the LED resin body differs depending on such factors as ultrasonic power and the assembled condition. Before cleaning, a pre-test should be confirm whether any damage to the LEDS will occur.

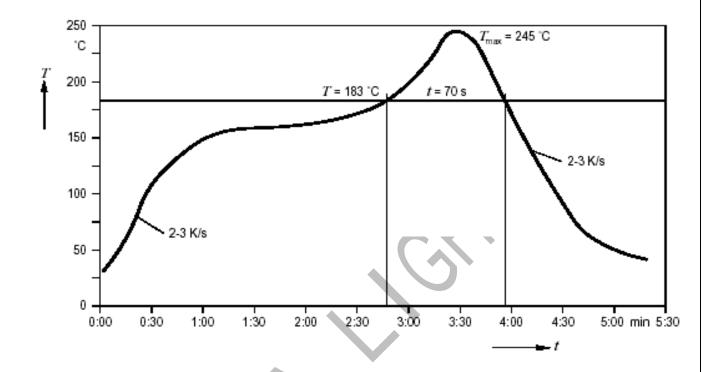
DRAWING NO.: DS-7A-07-0006 DATE: 2020-08-31 PAGE 10of 15



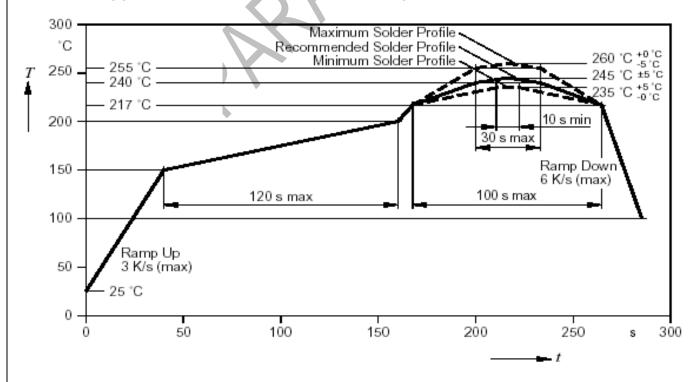
Part No.: L-T670LBCT-U1

REV: B/2

• Suggest Sn/Pb IR Reflow Soldering Profile Condition:



• Suggest Pb-Free IR Reflow Soldering Profile Condition:



DRAWING NO.: DS-7A-07-0006 DATE: 2020-08-31 PAGE 11 of 15



Part No.: L-T670LBCT-U1 REV: B/2

CAUTIONS

1. Static Electricity:

* Static electricity or surge voltage damages the LEDs.

It is recommended that a wrist band or an anti-electrostatic glove be used when handling the LEDs.

* All devices, equipment and machinery must be properly grounded.

It is recommended that measures be taken against surge voltage to the equipment that mounts the LEDs.

- * When inspecting the final products in which LEDs were assembled, it is recommended to check whether the assembled LEDs are damaged by static electricity or not. It is easy to find static-damaged LEDs by a light-on test or a VF test at a lower current (blew 1mA is recommended).
- * Damaged LEDs will show some unusual characteristics such as the leak current remarkably increases, the forward voltage becomes lower, or the LEDs do not light at the low current.

Criteria: (VF>2.0V, at IF=0.5m A)

2. Storage:

* before opening the package:

The led should be kept at 30 c or less, 85 % RH or less. When the led is stored, a moisture proof packaging with absorbent material (silica gel) is recommended.

* after opening the package:

The led should be kept at 30 c or less, 70 % RH or less. After unpacking, the led welding is 168 hours (7 days). If the unused led indicator is still present, it should be stored in a moisture proof package, such as a sealed container with a moisture proof material (silica gel). It is also recommended to return the led to the original moisture proof bag, and to pack the moisture-proof bag again. If the moisture absorption material (silica gel) fades or the led exceeds the storage time (the unopened led is valid for 6 months), the following conditions should be used before baking.

Baking treatment: 65 $^{\circ}$ C, more than 24 hours.

avoid rapid changes in ambient temperature in a high humidity environment where condensation may occur.3.

3. Soldering:

Do not apply any stress to the LED lens during soldering while the LED is at high temperature. Recommended soldering condition.

* Reflow Soldering:

Pre-heat 120~150°C, 120sec. MAX., Peak temperature : 240°C Max. Soldering time : 10 sec Max.

* Soldering Iron: (Not recommended)

Temperature 350°C Max., Soldering time: 3 sec. Max. (one time only), power dissipation of iron: 20W Max. use SN60 solder of solder with silver content and don't to touch LED lens when soldering.

DRAWING NO.: DS-7A-07-0006 DATE: 2020-08-31 PAGE 12 of 15



Part No.: L-T670LBCT-U1 REV: B/2

4. Lead-Free Soldering

For Reflow Soldering:

1 · Pre-Heat Temp: 150-180°C,120sec.Max.

2 Soldering Temp: Temperature Of Soldering Pot Over 240°C,40sec.Max.

 $3 \cdot \text{Peak Temperature: } 260^{\circ}\text{C} \cdot 10\text{sec.}$

4 \ Reflow Repetition: 2 Times Max.

5 ` Suggest Solder Paste Formula : 93.3 Sn/3.1 Ag/3.1 Bi/0.5 Cu

For Soldering Iron (Not Recommended):

1 ` Iron Tip Temp: 350°C Max.

2 \ Soldering Iron: 30w Max.

3 \ Soldering Time: 3 Sec. Max. One Time.

5. Drive Method

Circuit model B

- (A)Recommended circuit.
- (B)The difference of brightness between LED's could be found due to the Vf-If characteristics of LED.

6. Reliability

1. Criteria For Judging The Damage

| Thomas | Cyrosh ol | Test Conditions | Criteria for Judgement | | |
|--------------------|-----------|-----------------|------------------------|--------------|--|
| Item Symbol | | Test Conditions | MIN. | Max. | |
| Forward Voltage | VF | IF=20mA | - | U.S.L.*)×1.1 | |
| Reverse Current | IR | VR=5V | - | U.S.L.*)×2.0 | |
| Luminous Intensity | IV | IF=20mA | L.S.L**)×0.7 | - | |

*) U.S.L.: Upper Standard Level

**) L.S.L: Lower Standard Level

DRAWING NO.: DS-7A-07-0006 DATE: 2020-08-31 PAGE 13 of 15



Part No.: L-T670LBCT-U1 REV: B/2

2. Test Items And Results

| Test Item | Reference Standard | Test Condition | Note | Number of Damaged |
|---|-----------------------------|--|-------------------|-------------------------|
| Resistance to Soldering Heat (Reflow Soldering) | JEITA ED-4701300 301 | Tsld= 260° C, 10 sec. (Pre treatment 30° C, 70° , 168 hrs) | 2times | 0/50 |
| Solder ability (Reflow Soldering) | JEITA ED-4701300 303 | Tsld=215°C,3sec. (Lead Solder) | 1time over 95% | 0/50 |
| Thermal Shock | JEITA ED-4701300 307 | -40°C ~ 100°C 30min. 30min. | 100cycles | 0/50 |
| Temperature Cycle | JEITA ED-4701100 105 | -40°C ~ 25°C~100°C~25°C 30min. 5min. 30min. 5min | 100cycles | 0/50 |
| High Temperature Storage | JEITA ED-4701200- 201 | Ta=100°C | 1000hrs. | 0/50 |
| Temperature Humidity Storage | JEITA ED-4701100 103 | Ta=60°C,RH=90% | 1000hrs. | 0/50 |
| Low Temperature Storage | JEITA ED-4701200 202 | Ta=-40°C | 1000hrs. | 0/50 |
| Steady State Operating Life Condition | | Ta=25℃,IF=20mA | 1000hrs. | 0/50 |
| Steady State Operating Life of High Temperature | | Ta=85°C,IF=5mA | 500hrs. | 0/50 |
| Steady State Operating Life of High Humidity Heat | | Ta=60°C,RH=90%,IF=15mA | 500hrs. | 0/50 |
| Steady State Operating Life of Low Temperature | | Ta=-30°C,IF=20mA | 500hrs. | 0/50 |
| Vibration | JEITA ED-4701400 403 | 100~2000~100HzSweep 4min.200m/s ² 3direction,4cycles | 48min | 0/50 |
| Substrate Bending | JEITA ED-4702 | 3mm,5±1sec | 1time | 0/50 |
| Stick | JEITA ED-4702 | 5N,10±1sec | 1time | 0/50 |

7.Others:

The appearance and specifications of the product may be modified for improvement without notice.

DRAWING NO.: DS-7A-07-0006 DATE: 2020-08-31 PAGE 14 of 15



Part No.: L-T670LBCT-U1 REV: B/2

3. PART NO. SYSTEM_↑: XXXX: Special specification for customer $L - \underline{T} \underline{670} \underline{X} \underline{X} \underline{T} - \underline{X} \underline{X} \underline{X} \underline{X}$ T: Taping for 7 inch reel TC: Taping for 13 inch reel Lens color C: Water Clear W: White Diffused T: Color Transparent D: Color Diffused KY: 9mil AlInGap 590nm Super Yellow KR: 9mil AlInGap 630 nm Super Red TE: 14mil AlInGap 624 nm Super Red TY: 14mil AlInGap590 nm Super Yellow LB: InGaN ITO rough 470nm Blue LG: InGaN ITO rough520nm Green W: InGaN + YAG White color 0 : Single chip 1/2 : Super thin single chip 5/6: Dual chip F: Three chip(Full color) 650: 3020 1.3T **TYPE** 670: 3528 1.9T **TYPE** 0.6T C: PCB Top View Type 020: 3812 **TYPE** T:PLCC Top View Type S: Side View Type

DRAWING NO.: DS-7A-07-0006 DATE: 2020-08-31 PAGE 15 of 15